# NPN Silicon Power Transistor

# High Voltage SWITCHMODE<sup>™</sup> Series

Designed for use in electronic ballast (light ballast) and in Switchmode Power supplies up to 50 Watts.

#### Features

- Improved Efficiency Due to:
  - Low Base Drive Requirements (High and Flat DC Current Gain hFE)
  - Low Power Losses (On–State and Switching Operations)
  - Fast Switching:  $t_{fi} = 100$  ns (typ) and  $t_{si} = 3.2 \ \mu s$  (typ)
  - @  $I_C = 2.0 \text{ A}, I_{B1} = I_{B2} = 0.4 \text{ A}$
- Full Characterization at 125°C
- Tight Parametric Distributions Consistent Lot-to-Lot
- Pb–Free Package is Available\*

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Sustaining Voltage	V <sub>CEO</sub>	400	Vdc
Collector-Base Breakdown Voltage	V <sub>CES</sub>	700	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	9.0	Vdc
Collector Current – Continuous – Peak (Note 1)	I <sub>C</sub> I <sub>CM</sub>	5.0 10	Adc
Base Current	Ι <sub>Β</sub>	2.0	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	75 0.6	W W/°C
Operating and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to 150	°C

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.65	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle  $\leq$  10%.



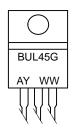
## **ON Semiconductor®**

http://onsemi.com

# POWER TRANSISTOR 5.0 AMPERES, 700 VOLTS, 35 AND 75 WATTS



#### MARKING DIAGRAM



BUL45	= Device Code
А	= Assembly Location
Y	= Year
WW	= Work Week
G	= Pb-Free Package

#### ORDERING INFORMATION

Device	Package	Shipping
BUL45	TO-220	50 Units / Rail
BUL45G	TO-220 (Pb-Free)	50 Units / Rail

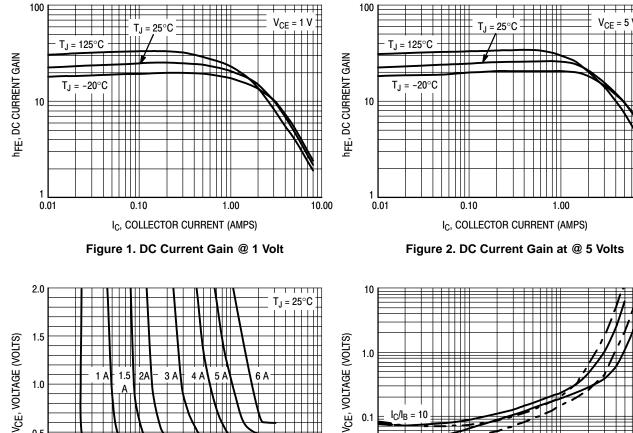
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

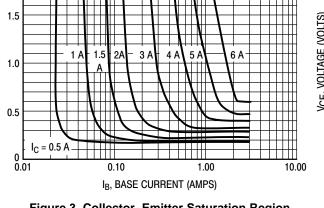
© Semiconductor Components Industries, LLC, 2006 February, 2006 – Rev. 7

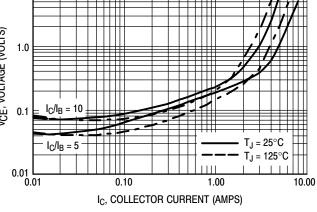
# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

C	Characteristic			Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Collector-Emitter Sustaining Voltage (I <sub>C</sub> = 100 mA, L = 25 mH)				V <sub>CEO(sus)</sub>	400	-	-	Vdc
Collector Cutoff Current ( $V_{CE}$ = Rated $V_{CEO}$ , $I_B$ = 0)				I <sub>CEO</sub>	_	-	100	μAdc
Collector Cutoff Current (V <sub>CE</sub> = Rated V <sub>CES</sub> , V <sub>EB</sub> = 0) (T <sub>C</sub> = 125°C)				ICES	-		10 100	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 9	.0 Vdc, I <sub>C</sub> = 0)			I <sub>EBO</sub>	-	-	100	μAdc
ON CHARACTERISTICS								
Base-Emitter Saturation Voltage $(I_C = 1.0 \text{ Adc}, I_B = 0.2 \text{ Adc})$ $(I_C = 2.0 \text{ Adc}, I_B = 0.4 \text{ Adc})$			V <sub>BE(sat)</sub>		0.84 0.89	1.2 1.25	Vdc	
Collector-Emitter Saturation Vo	• • •	I <sub>B</sub> = 0.2 / (T <sub>C</sub> = 125	'	V <sub>CE(sat)</sub>		0.175 0.150	0.25 -	Vdc
Collector-Emitter Saturation Vo	ltage (I <sub>C</sub> = 2.0 Adc,	I <sub>B</sub> = 0.4 / T <sub>C</sub> = 125	Adc) °C)	V <sub>CE(sat)</sub>	-	0.25 0.275	0.4	Vdc
$ \begin{array}{l} \mbox{DC Current Gain (I_C = 0.3 Adc, V_{CE} = 5.0 Vdc)} \\ (I_C = 2.0 Adc, V_{CE} = 1.0 Vdc) \\ (I_C = 10 \mbox{mAdc}, V_{CE} = 5.0 Vdc) \end{array} (T_C = 125^{\circ}C) \\ \end{array} $			h <sub>FE</sub>	14 - 7.0 5.0 10	- 32 14 12 22	34 - - - -	_	
DYNAMIC CHARACTERISTIC		f = 1.0		f_	_	12	_	MHz
Current Gain Bandwidth ( $I_C = 0.5 \text{ Adc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ MHz}$ ) Output Capacitance ( $V_{CB} = 10 \text{ Vdc}$ , $I_E = 0$ , $f = 1.0 \text{ MHz}$ )			f <sub>T</sub> C <sub>ob</sub>	_	50	75	pF	
Input Capacitance ( $V_{EB} = 8.0 V$		vii iz)		C <sub>ib</sub>	_	920	1200	pF
input Capacitance (VEB - 0.0 V				C <sub>ib</sub>		1.75	-	Pi
	$(I_{C} = 1.0 \text{ Adc})$ $I_{B1} = 100 \text{ mAdc}$ $V_{CC} = 300 \text{ V}$	1.0 μs	(T <sub>C</sub> = 125°C)	V <sub>CE</sub> (Dyn sat)	_	4.4	_	Vdc
Dynamic Saturation Voltage: Determined 1.0 $\mu$ s and 3.0 $\mu$ s respectively after rising I <sub>B1</sub> reaches 90% of final I <sub>B1</sub>		3.0 μs	(T <sub>C</sub> = 125°C)		-	0.5 1.0		
	$(I_{\rm C} = 2.0  {\rm Adc})$	1.0 μs	(T <sub>C</sub> = 125°C)		_	1.85 6.0		
(see Figure 18)	I <sub>B1</sub> = 400 mAdc V <sub>CC</sub> = 300 V)	3.0 μs	(T <sub>C</sub> = 125°C)		_ _	0.5 1.0	_	
SWITCHING CHARACTERIST	CS: Resistive Loa	d						
Turn–On Time	$(I_{C} = 2.0 \text{ Adc}, I_{B1} = I_{B2} = 0.4 \text{ Adc}$ Pulse Width = 20 µs, $(T_{C} = 125^{\circ}\text{C})$			t <sub>on</sub>	-	75 120	110 -	ns
Turn–Off Time	Duty Cycle < 20%	V <sub>CC</sub> = 30	00 V (T <sub>C</sub> = 125°C)	t <sub>off</sub>	_ _	2.8 3.5	3.5 -	μs
SWITCHING CHARACTERIST	ICS: Inductive Loa	<b>d</b> (V <sub>CC</sub> =	15 Vdc, L <sub>C</sub> = 200	$\mu$ H, V <sub>clamp</sub> = 3	00 Vdc)			
Fall Time	$(I_{C} = 2.0 \text{ Adc}, I_{B1} = I_{B2} = 0.4 \text{ Adc})$	= 0.4 Adc	: (T <sub>C</sub> = 125°C)	t <sub>fi</sub>	70 -	_ 200	170 -	ns
Storage Time			(T <sub>C</sub> = 125°C)	t <sub>si</sub>	2.6 -	_ 4.2	3.8 -	μs
Crossover Time			(T <sub>C</sub> = 125°C)	t <sub>c</sub>	_ _	230 400	350 -	ns
Fall Time	$(I_C = 1.0 \text{ Adc}, I_{B1} = 100 \text{ mAdc}$ $I_{B2} = 0.5 \text{ Adc})$ $(T_C = 125^{\circ}\text{C})$			t <sub>fi</sub>		110 100	150 -	ns
Storage Time	$(T_{\rm C} = 125^{\circ}{\rm C})$			t <sub>si</sub>		1.1 1.5	1.7 -	μs
Crossover Time			(T <sub>C</sub> = 125°C)	t <sub>c</sub>	_ _	170 170	250 -	ns
Fall Time	(I <sub>C</sub> = 2.0 Adc, I <sub>B1</sub> = I <sub>B2</sub> = 2.0 Adc)	= 250 mA	, ,	t <sub>fi</sub>	_	80	120	ns
Storage Time	$(T_{\rm C} = 125 {\rm cC})$ $(T_{\rm C} = 125 {\rm cC})$			t <sub>si</sub>	_	0.6	0.9	μs
Crossover Time	1		(T <sub>C</sub> = 125°C)	t <sub>c</sub>	_	175	300	ns

#### **TYPICAL STATIC CHARACTERISTICS**







10.00

Figure 3. Collector-Emitter Saturation Region

Figure 4. Collector-Emitter Saturation Voltage

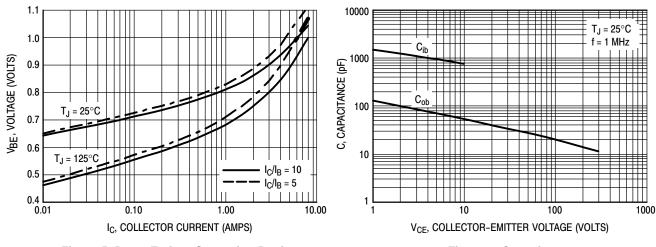
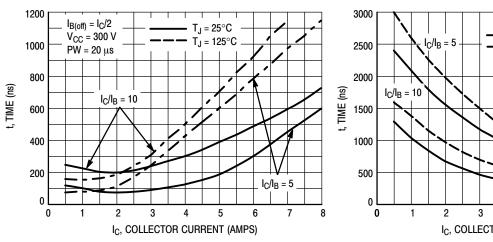


Figure 5. Base-Emitter Saturation Region

Figure 6. Capacitance



# TYPICAL SWITCHING CHARACTERISTICS $(I_{B2} = I_C/2 \text{ for all switching})$



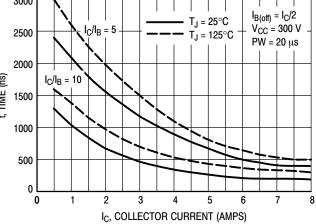


Figure 8. Resistive Switching, toff

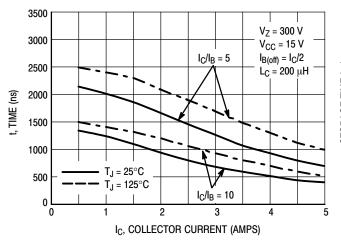


Figure 9. Inductive Storage Time, tsi

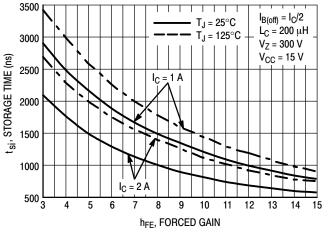


Figure 10. Inductive Storage Time, tsi(hFE)

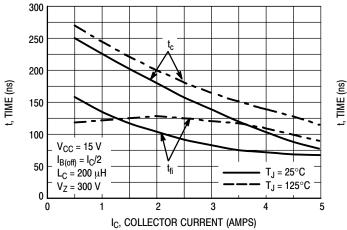


Figure 11. Inductive Switching,  $t_c \& t_{fi}$ ,  $I_C/I_B = 5$ 

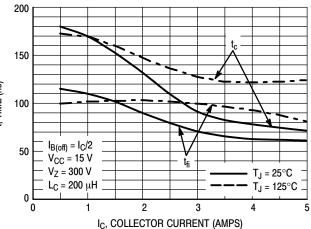


Figure 12. Inductive Switching,  $t_c \& t_{fi}$ ,  $I_C/I_B = 10$ 

**TYPICAL SWITCHING CHARACTERISTICS** 

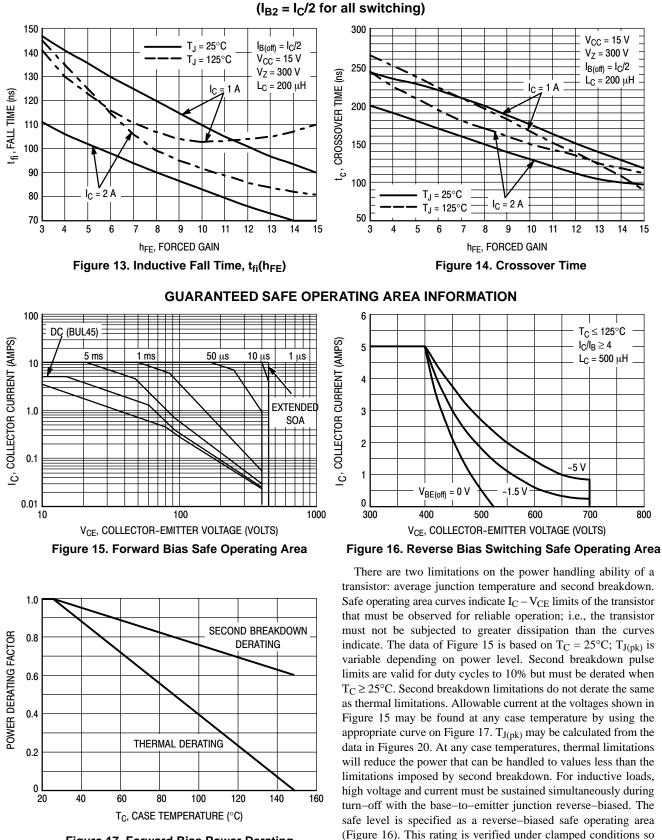
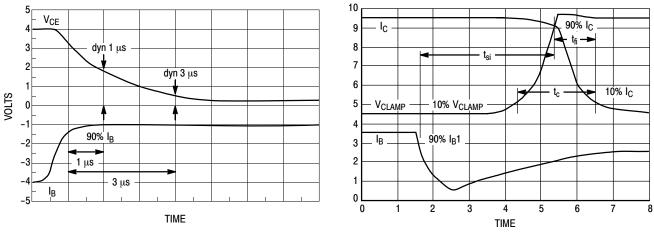


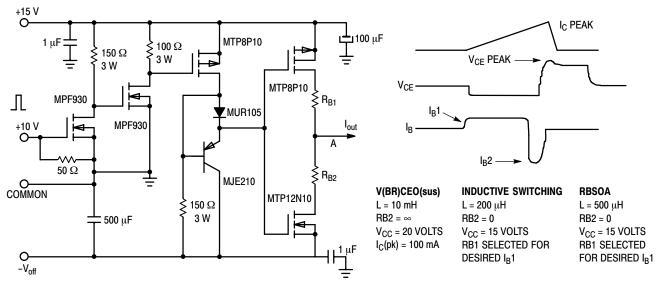
Figure 17. Forward Bias Power Derating

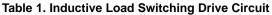
that the device is never subjected to an avalanche mode.

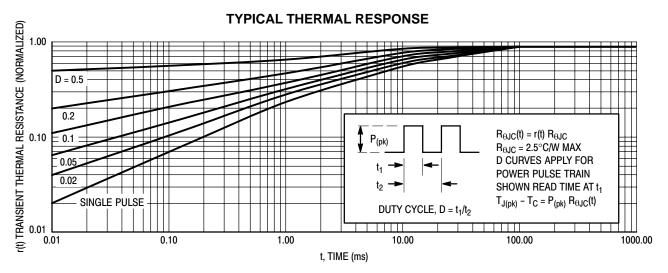






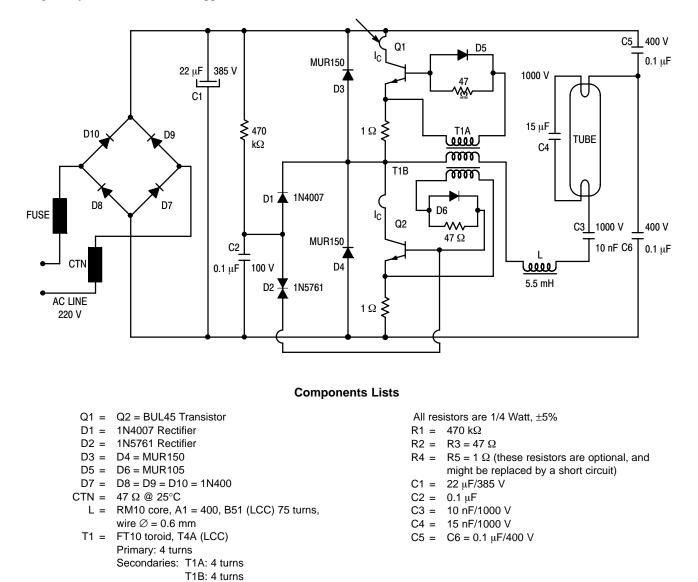








The BUL45 Bipolar Power Transistors were specially designed for use in electronic lamp ballasts. A circuit designed by ON Semiconductor applications was built to demonstrate how well these devices operate. The circuit and detailed component list are provided below.



#### NOTES:

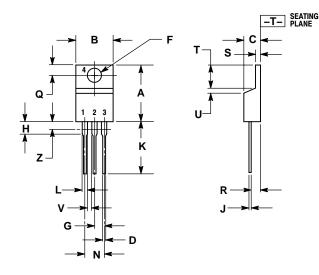
1. Since this design does not include the line input filter, it cannot be used "as-is" in a practical industrial circuit.

2. The windings are given for a 55 Watt load. For proper operation they must be re-calculated with any other loads.

#### Figure 21. Application Example

#### PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 ISSUE AA



NOTES:

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 CONTROLLING DIMENSION: INCH.
DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.018	0.025	0.46	0.64	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Ζ		0.080		2.04	

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

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